

#### **General Description**

The MAX328/MA329 are monolithic CMOS analog multiplexers. The MAX328 is a single-ended, 1-of-8 device, and the MAX329 is a differential, 2-of-8 device.

Designed to provide the lowest possible on- and off-leakages, these multiplexers switch signals from high source impedance, providing the mux operates into a high-input-impedance op amp or A/D converter. The MAX328/MAX329 are pin-for-pin replacements for the popular DG508/DG509 in these applications.

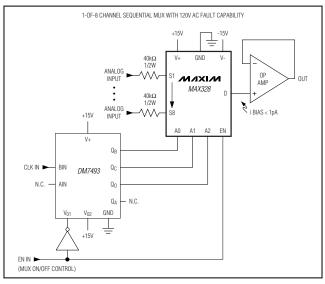
Adding an external  $40k\Omega$  resistor to each input makes the MAX328/MAX329 an excellent fault-tolerant multiplexer. Low leakage (less than 1pA at +25°C) and  $2.5k\Omega$  on-resistance allow the circuit to sustain 110V AC faults indefinitely while maintaining an error of less than 40nV for normal signals (i.e., 1pA times  $40k\Omega$ ).

The MAX328/MAX329 work equally well with a single supply of 10V to 30V or dual supplies of  $\pm$ 5V to  $\pm$ 18V. They also perform well with unbalanced combinations of supply voltage, such as  $\pm$ 12V and  $\pm$ 5V or  $\pm$ 5V and  $\pm$ 15V. Low power dissipation (1.9mW with  $\pm$ 15V supplies) allows use in portable applications.

#### **Applications**

Control Systems
Data Logging Systems
Aircraft Heads-Up Displays
Data-Acquisition Systems
Signal Routing

## Typical Operating Circuit



#### **Features**

- ♦ Ultra-Low Off- and On-Leakage: 1pA Typ
- ♦ Bidirectional Operation (Use as Mux or Demux)
- **♦ TTL and CMOS Logic Compatibility**
- ♦ Analog-Signal Range Includes Power-Supply Rails
- ♦ Switching Speeds Less Than 1.5µs
- Pin Compatible with DG508/DG509 and MAX358/MAX359
- **♦ Latchup Proof Construction**

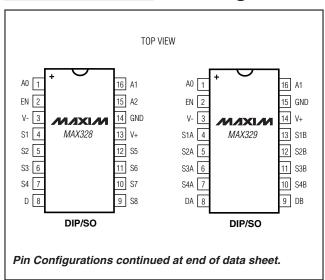
#### **Ordering Information**

PART	TEMP RANGE	PIN-PACKAGE
MAX328CPE+	0°C to +70°C	16 Plastic DIP
MAX328CWE+	0°C to +70°C	16 Wide SO
MAX328CJE	0°C to +70°C	16 CERDIP
MAX328C/D	0°C to +70°C	Dice*
MAX328ETE+	-40°C to +85°C	16 TQFN-EP**
MAX328EPE+	-40°C to +85°C	16 Plastic DIP
MAX328EWE+	-40°C to +85°C	16 Wide SO
MAX328EJE	-40°C to +85°C	16 CERDIP***
MAX328MJE	-55°C to +125°C	16 CERDIP***

- +Denotes a lead(Pb)-free/RoHS-compliant package.
- \*Contact factory for dice specifications.

Ordering Information continued at end of data sheet.

### **Pin Configurations**



Maxim Integrated Products 1

<sup>\*\*</sup>EP = Exposed pad.

<sup>\*\*\*</sup>Contact factory for availability. Substrate may be allowed to be unconnected or be connected to V+.

#### **ABSOLUTE MAXIMUM RATINGS**

Voltage Referenced to V-	
V+	+44V
GND	+25V
Digital Inputs (Note 1), V <sub>S</sub> , V <sub>D</sub>	2V to (V+ + 2V)
Current (Any Terminal, Except S or D)	30mA
Continuous Current, S or D	
(pulsed at 1ms, 10% duty cycle max)	40mA
Operating Temperature Range	
MAX328/329 C	0°C to +70°C
MAX328/329 E	40°C to +85°C
MAX328/329 M	55°C to +125°C

Power Dissipation (Package) (Note 1)	
CERDIP (derate 10mW/°C above +70°C)	800mW
PDIP (derate 10.5mW/°C above +70°C)	842.1mW
Wide SO (derate 14.3mW/°C above +70°C)	1142.9mW
TQFN (derate 33.3mW/°C above +70°C)	2666.7mw
Storage Temperature	65°C to +150°C
Lead Temperature (soldering, 10s)	+300°C
Soldering Temperature (reflow)	
Lead(Pb)-free packages (PDIP, TQFN, Wide	SO)+260°C
Packages containing lead(Pb) (CERDIP, PDIP, \	Vide SO)+240°C
Packages containing lead(Pb) (TQFN)	+260°C

Note 1: All leads soldered or welded to PC board.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### **ELECTRICAL CHARACTERISTICS**

(V+ = 15V, V- = -15V, V<sub>GND</sub> = 0V, **T<sub>A</sub> = +25°C**, unless otherwise noted.) (Note 2)

PARAM	/IETER	SYMBOL	CONDITIONS			1AX328 1AX329		1	AX3280 AX3290	-	UNITS	
					MIN	TYP	MAX	MIN	TYP	MAX		
SWITCH												
Analog Signa	al Range	Vanalog			-15		+15	-15		+15	V	
Drain-Source		Process	$V_D = 10V,$ $I_S = 100\mu A$	Seq. each switch on,		1.5	2.5		1.5	3.5		
On-Resistan	ce			$V_{AL} = 0.8V,$ $V_{AH} = 2.4V$		1.0	2.5		1.0	3.5	kΩ	
Drain-Source	reatest Change in ain-Source On- esistance Between $\Delta R_{DS(ON)} = R_{DS(ON)} = R_{DS(ON)} Max - R_{DS(ON)} Min$		N) <b>Min</b>		2			2		%		
Channels			RDS(ON) AVE	,								
Source Off-Le	eakage	lovore)	$V_{S} = 10V, V_{D} = -10V$ $V_{EN} = 0V$		0.1	±10		0.1	±10	рА		
Current (Note	3)	IS(OFF)	$V_S = -10V, V_D = 10V$	VEN - OV		0.3	±10		0.3	±10	PΑ	
Drain Off-	MAX328		$V_D = 10V, V_S = -10V$			0.3	±10		0.3	±10		
Leakage	IVIAASZO	ID (OFF)	$V_D = -10V, V_S = 10V$	V <sub>EN</sub> = 0V		1.0	±10		1.0	±10	рА	
Current	MAX329	ID(OFF)	V <sub>D</sub> = 10V, V <sub>S</sub> = -10V	VEN = UV		0.3	±10		0.3	±10	] PA	
(Note 3)	IVIAASZS		$V_D = -10V, V_S = 10V$			0.5	±10		0.5	±10		
Drain On-	MAX328		$V_{S}$ (all) = $V_{D}$ = 10V	S(all) = VD = 10V Seq. each		3.0	±10		3.0	±10		
Leakage	IVIANUZO	ln (o.u)	$V_{S}$ (all) = $V_{D}$ = -10 $V$	switch on,		2.0	±10		2.0	±10		
Current	MAX329	ID(ON)	$V_{S}$ (all) = $V_{D}$ = 10V	$V_{AL} = 0.8V,$		1.5	±10		1.5	±10	PA	
(Note 3)	INITAGES		$V_{S}$ (all) = $V_{D}$ = -10 $V$	$V_{AH} = 2.4V$		1.0	±10		1.0	±10		

#### **ELECTRICAL CHARACTERISTICS (continued)**

 $(V+ = 15V, V- = -15V, V_{GND} = 0V, T_A = +25^{\circ}C, unless otherwise noted.)$  (Note 2)

PARAM	ETER	SYMBOL	CONDITIONS			IAX328 IAX329			AX3280 AX3290		UNITS	
					MIN	TYP	MAX	MIN	TYP	MAX		
INPUT												
Address Inpu	it Current,	I <sub>AH</sub>	$V_A = 2.4V$			0.001	±1		0.001	±1	μA	
Input Voltage	High	IAH	$V_A = 15V$			0.001	±1		0.001	±1	μΑ	
Address Inpu	,	I <sub>AL</sub>	$V_{EN} = 2.4V$	All		0.001	±1		0.001	±1	μA	
Input Voltage	Low	IAL	$V_{EN} = 0V$	$V_A = 0V$		0.001	±1		0.001	±1	μΛ	
DYNAMIC												
Switching Tim Multiplexer	ne of	ttransition	Figure 1				1.0			1.5	μs	
Break-Before Interval	-Make	topen	Figure 2			0.2			0.2		μs	
Enable Turn-0	On Time	ton(EN)	Figure 3				1.0			1.5	μs	
Enable Turn-0	Off Time	toff(EN)	Figure 3				0.7			1.0	μs	
Off-Isolation		OIRR	$V_{EN} = 0V$ , $R_L = 1k\Omega$ , $C_{VS} = 7V_{RMS}$ , $f = 500kH$			84			84		dB	
Source Off-Ca	apacitance	C <sub>S(OFF)</sub>	V <sub>S</sub> = 0V	$V_{EN} = 0V,$ f = 1MHz		1.8			1.8		pF	
Drain Off-	MAX328	Cn.(off)	Vn = 0V	V <sub>EN</sub> = 0V,		8.0			8.0		pF	
Capacitance	MAX329	C <sub>D(OFF)</sub>	vD = 0v	f = 1MHz		4.0			4.0		] Pr	
01			V <sub>A</sub> = 10V			1			1			
Charge Injection (Note 4)		Q(INJ)	$V_A = 0V$			2	5		2	5	рс	
(14010 4)			V <sub>A</sub> = -10V			4			4			
SUPPLY												
Positive Supp	oly Current	l+	$V_{EN} = 2.4V$	$V_A = 0V/5V$		4.5	200		4.5	200	μΑ	
Negative Sup	ply Current	l-	$V_{EN} = 2.4V$	V <sub>A</sub> = 0V/5V		1	-100		1	-100	μΑ	
Power-Supply Continuous C (Note 7)	_	Vop			±5		±18	±5		±18	V	

#### **ELECTRICAL CHARACTERISTICS (Overtemperature)**

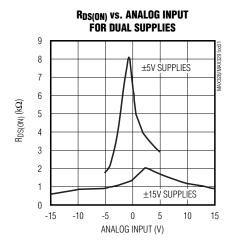
 $(V+ = 15V, V- = -15V, V_{GND} = 0V, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted.})$  (Note 2)

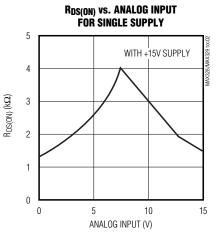
PARAI	METER	SYMBOL	SYMBOL TEST CONDITIONS			1AX328 1AX329			AX3280 AX3290		UNITS
					MIN	TYP	MAX	MIN	TYP	MAX	]
SWITCH											
Analog-Sign	al Range	V <sub>ANALOG</sub>			-15		+15	-15		+15	V
Drain-Source	e	Proyecti	$V_D = 10V,$ $I_S = 100\mu A$	Seq. each switch on,		2.2	4		1.9	5	kΩ
On-Resistan	ice	R <sub>DS</sub> (ON)	$V_D = -10V,$ $I_S = 100\mu A$	$V_{AL} = 0.8V, V_{AH} = 2.4V$		1.5	4		1.2	5	N52
Source Off-L	eakage	1-1	$V_S = 10V, V_D = -10V$	\/ O\/			±5			±5	0
Current (Note	e 6)	IS(OFF)	$V_S = -10V, V_D = 10V$	$V_{EN} = 0V$			±5			±5	nA
Drain Off-	MAX328		V <sub>D</sub> = 10V, V <sub>S</sub> = -10V				±20			±20	
Leakage	IVIAA320	I <sub>D(OFF)</sub>	$V_D = -10V, V_S = 10V$	V <sub>FN</sub> = 0V			±20			±20	nA
Current	MAX329	$V_{D} = 10V V_{S} = -10V V_{S}$	VEN - OV			±10			±10		
(Note 6)	IVIANOZO		$V_D = -10V, V_S = 10V$				±10			±10	
Drain On-	MAX328		$V_{S}$ (all) = $V_{D}$ = 10V	Seq. each			±20			±20	
Leakage	1017 07020	I <sub>D(ON)</sub>	$V_{S}$ (all) = $V_{D}$ = -10V	switch on,			±20			±20	nA
Current	MAX329	$V_{S}(all) = V_{D} = 10V  V_{AL} = 0.8$	$V_{AL} = 0.8V,$			±10			±10	] '"`	
(Note 6)	IVII VIOLO		$V_{S}$ (all) = $V_{D}$ = -10V	$V_{S}$ (all) = $V_{D}$ = -10 $V$ $V_{AH}$ = 2.4 $V$			±10			±10	
INPUT		_									
Address Inp		I <sub>AH</sub>	V <sub>A</sub> = 2.4V	_		0.01	±1		0.01	±1	μA
Input Voltage	e High	'An	V <sub>A</sub> = 15V			0.01	±1		0.01	±1	μ, τ
Address Inp		I <sub>AL</sub>	V <sub>EN</sub> = 2.4V	AII		0.01	±1		0.01	±1	μΑ
Input Voltage	e Low	'AL	V <sub>EN</sub> = 0V	V <sub>A</sub> = 0V		0.01	±1		0.01	±1	μ/ (

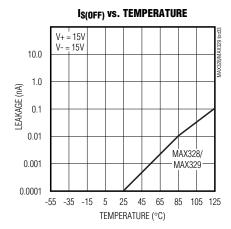
- Note 2: Typical values are for design aid only; not guaranteed or subject to production testing.
- Note 3: All leakage parameters are 100% tested at maximum rated operating temperature, i.e., +70°C, +85°C, +125°C, and guaranteed by correlation at +25°C.
- Note 4: Guaranteed by design.
- Note 5: Electrical characteristics, such as On-Resistance, change when power supplies other than ±15V are used. Power-supply range is a design characteristic, not production tested.
- Note 6: Leakage parameters are 100% tested at maximum rated operating temperature, i.e., +70°C, etc.

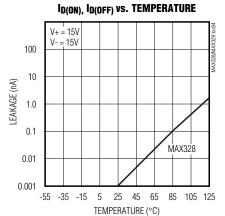
### **Typical Operating Characteristics**

 $(T_A = +25^{\circ}C, \text{ unless otherwise noted.})$ 









### **Pin Description**

	P	IN			
MAX	(328	MAX	(329	NAME	FUNCTION
DIP/SO	TQFN-EP	DIP/SO	TQFN-EP		
1, 15, 16	15, 14, 13	_	_	A0, A2, A1	Address Input
_	_	1, 16	15, 14	A0, A1	Address Input
2	16	2	16	EN	Enable
3	1	3	1	V-	Negative-Supply Voltage Input
4–7	2–5	_	_	S1–S4	Analog Inputs—Bidirectional
_	_	4–7	2–5	S1A-S4A	Analog Inputs—Bidirectional
8	6	_	_	D	Analog Outputs—Bidirectional
_	_	8, 9	6, 7	DA, DB	Analog Outputs—Bidirectional
9–12	7–10	_	_	S8-S5	Analog Inputs—Bidirectional
_	_	10–13	8–11	S4B-S1B	Analog Inputs—Bidirectional
13	11	14	12	V+	Positive-Supply Voltage Input
14	12	15	13	GND	Ground
_	_	_	_	EP	Exposed pad. Connect EP to V+. (TQFN only).

#### Truth Table—MAX328

A2	<b>A</b> 1	Α0	EN	ON SWITCH
Х	Χ	Χ	0	None
0	0	0	1	1
0	0	1	1	2
0	1	0	1	3
0	1	1	1	4
1	0	0	1	5
1	0	1	1	6
1	1	0	1	7
1	1	1	1	8

#### Truth Table—MAX329

A1	Α0	EN	ON SWITCH
X	Χ	0	None
0	0	1	1
0	1	1	2
1	0	1	3
1	1	1	4

**Note:** Logic "0" =  $V_{AL} \le 0.8V$ , Logic "1" =  $V_{AH} \ge 2.4V$ 

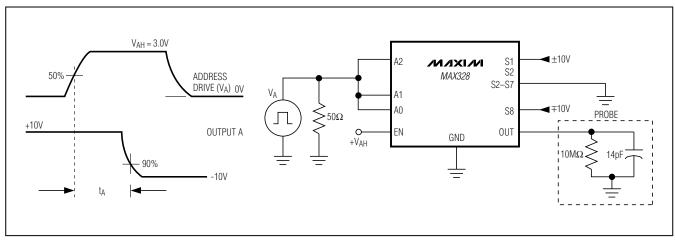


Figure 1. Access Time vs. Logic Level (High)

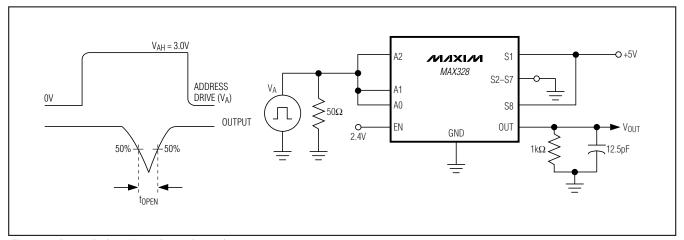


Figure 2. Break-Before-Make Delay (t<sub>OPEN</sub>)

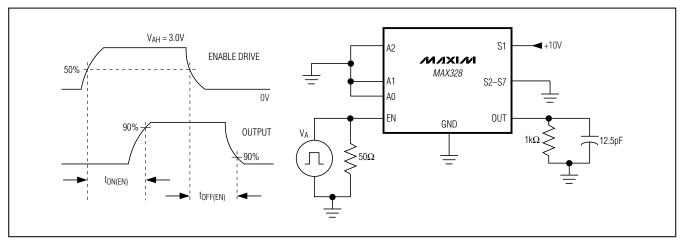


Figure 3. Enable Delay (ton(EN), toff(EN))

### Applications Information

Figure 4 is a typical circuit for converting the MAX328/MAX329 into a fault-tolerant mux. In this application, the internal diodes limit the voltage at the MAX328 input to ±15.7V (±15V supplies). No external diodes need to be added with the MAX328/MAX329, unlike conventional multiplexers requiring external diodes.

The resistors, R, need to be  $39k\Omega$  or higher to limit the power dissipation in the resistor when a 120V AC fault occurs (i.e., power dissipation is (120-16)²/39k $\Omega$  or 0.28W. This is why a 1/2/W resistor is needed). The circuit withstands an indefinite fault to a 120V AC line with no damage to any component.

In addition to allowing fault-protection, the guaranteed low leakage of the MAX328/MAX329 also reduces signal errors. The circuit in Figure 4 produces an error voltage of 10pA (max leakage) x 39k $\Omega$  or 0.39 $\mu$ V at room temperature and 39 $\mu$ V at +125°C. Therefore, for 10V signals, the MAX328/MAX329 allows 17-bit resolution (38 $\mu$ V = 1LSB) over the full temperature range.

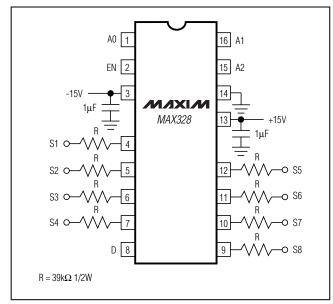
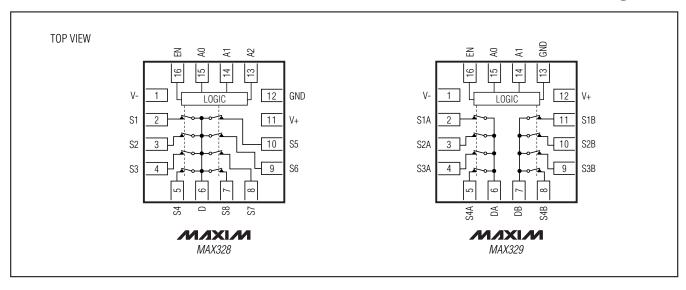


Figure 4. Fault-Tolerant Mux (indefinitely withstands 120V AC fault voltages)

#### **Functional Diagrams**



### Ordering Information (continued)

PART	TEMP RANGE	PIN-PACKAGE
MAX329CPE+	0°C to +70°C	16 Plastic DIP
MAX329CWE+	0°C to +70°C	16 Wide SO
MAX329CJE	0°C to +70°C	16 CERDIP
MAX329C/D	0°C to +70°C	Dice*
MAX329ETE+	-40°C to +85°C	16 TQFN-EP**
MAX329EPE+	-40°C to +85°C	16 Plastic DIP
MAX329EWE+	-40°C to +85°C	16 Wide SO
MAX329EJE	-40°C to +85°C	16 CERDIP***
MAX329MJE	-55°C to +125°C	16 CERDIP***

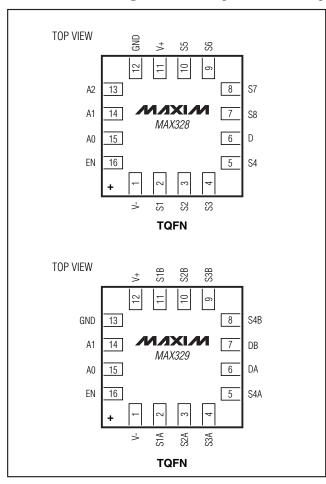
<sup>+</sup>Denotes a lead(Pb)-free/RoHS-compliant package.

#### Package Information

For the latest package outline information and land patterns (footprints), go to <a href="https://www.maxim-ic.com/packages">www.maxim-ic.com/packages</a>. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE TYPE	PACKAGE CODE	OUTLINE NO.	LAND PATTERN NO.
16 CERDIP	J16+3	21-0045	_
16 PDIP	P16+2	21-0043	_
16 TQFN-EP	T1655+3	21-0140	<u>90-0073</u>
16 Wide SO	W16+2	21-0042	<u>90-0107</u>

### Pin Configurations (continued)



<sup>\*</sup>Contact factory for dice specifications.

<sup>\*\*</sup>EP = Exposed pad.

<sup>\*\*\*</sup>Contact factory for availability. Substrate may be allowed to be unconnected or be connected to V+.

## **Revision History**

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
3	2/11	Updated the <i>Ordering Information</i> table to reflect lead-free parts and corrected part numbers and package types	1, 9

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